

2SK2380

Silicon N-Channel Junction

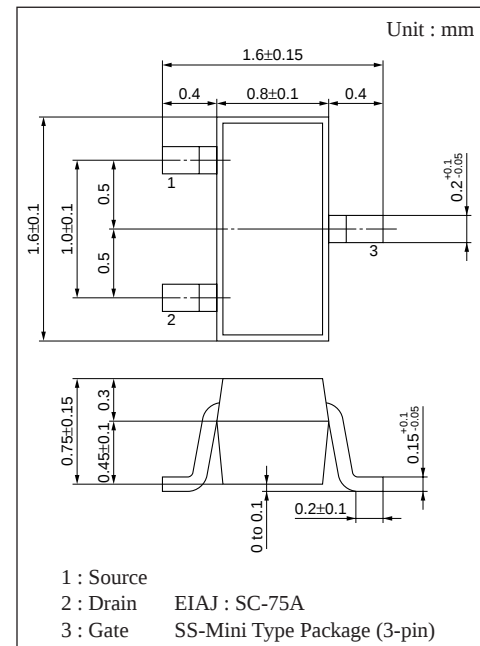
For impedance conversion in low frequency
For infrared sensor

■ Features

- Low gate-source leakage current, I_{GSS}
- Small capacitance of C_{iss} , C_{oss} , C_{rss}
- Downsizing of sets by mini-type package and automatic insertion by taping/magazine packing are available.

■ Absolute Maximum Ratings ($T_c = 25^\circ\text{C}$)

Parameter	Symbol	Rating	Unit
Gate-Drain voltage	V_{GDO}	- 40	V
Gate-Source voltage	V_{GSO}	- 40	V
Drain current	I_D	± 1	mA
Gate current	I_G	10	mA
Allowable power dissipation	P_D	125	mW
Channel temperature	T_{ch}	125	$^\circ\text{C}$
Storage temperature	T_{stg}	- 55 to +125	$^\circ\text{C}$



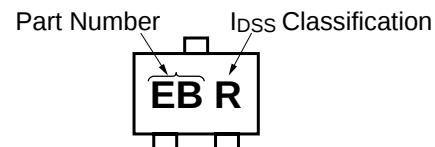
■ Electrical Characteristics ($T_a = 25^\circ\text{C}$)

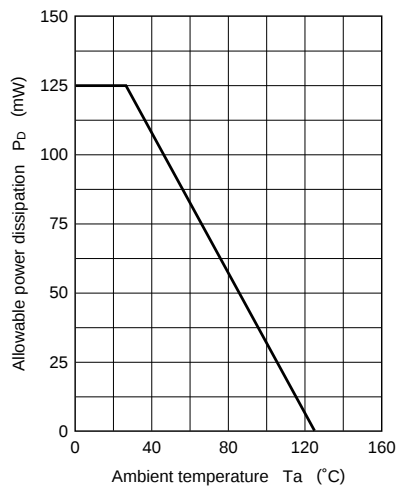
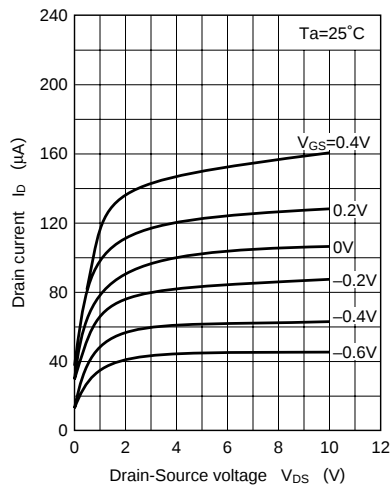
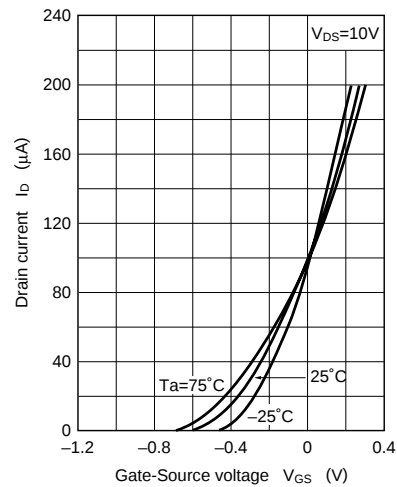
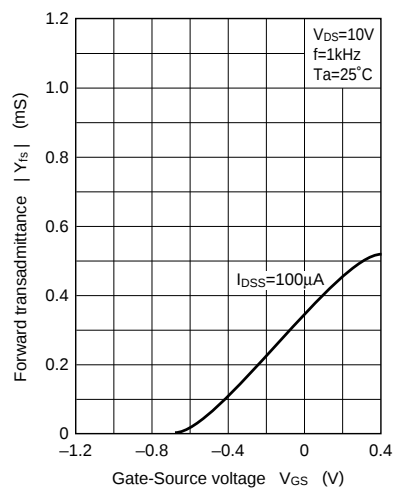
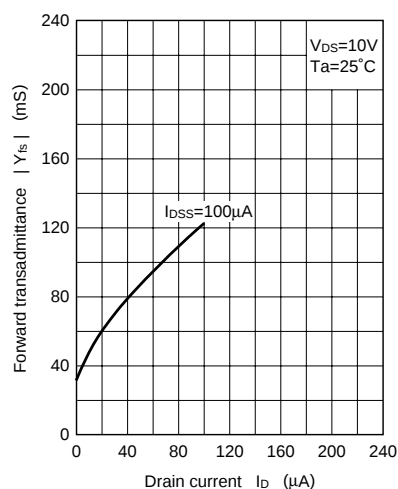
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Drain-Source cut-off current	I_{DSS}^*	$V_{DS}=10\text{V}, V_{GS}=0$	50		200	μA
Gate-Source leakage current	I_{GSS}	$V_{GS}=-20\text{V}, V_{DS}=0$			- 0.5	nA
Gate-Drain voltage	V_{DS}	$I_{GS}=-10\mu\text{A}, V_{DS}=0$	- 40			V
Gate-Source cut-off voltage	V_{GSC}	$V_{DS}=10\text{V}, I_D=1\mu\text{A}$		-1.3	- 3	V
Forward transadmittance	$ Y_{fs} $	$V_{DS}=10\text{V}, V_{GS}=0, f=1\text{kHz}$	0.05			mS
Input capacitance	C_{iss}	$V_{DS}=10\text{V}, V_{GS}=0, f=1\text{MHz}$		1		pF
Output capacitance	C_{oss}			0.4		pF
Feedback capacitance	C_{rss}			0.4		pF

* I_{DSS} rank classification

Rank	Q	R	S
$I_{DSS}(\text{mA})$	50 to 100	70 to 130	100 to 200
Part number symbol	EB Q	EB R	EB S

■ Marking (Example)



$P_D - T_a$  $I_D - V_{DS}$  $I_D - V_{GS}$  $|Y_{fs}| - V_{GS}$  $|Y_{fs}| - I_D$  $C_{iss}, C_{oss}, C_{rss} - V_{DS}$ 